Triacs BT139X series

## **GENERAL DESCRIPTION**

## **QUICK REFERENCE DATA**

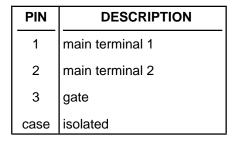
Passivated triacs in a full pack, plastic envelope, intended for use in applications requiring high bidirectional transient and blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

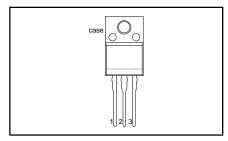
| SYMBOL                                  | PARAMETER  | MAX.                | MAX.      | UNIT   |
|---|--|---------------------|-----------|--------|
|   | BT139X-<br>BT139X-<br>BT139X-                                      | 600<br>600F<br>600G | 800       |        |
| $V_{DRM}$                               | Repetitive peak off-state  | 600                 | 800       | V      |
| I <sub>T(RMS)</sub><br>I <sub>TSM</sub> | voltages RMS on-state current Non-repetitive peak on-state current | 16<br>140           | 16<br>140 | A<br>A |

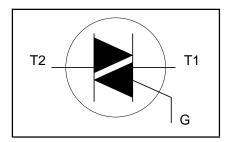
## **PINNING - SOT186A**

| PIN | CO | NF | GU | IR A | IT | ON | J |
|-----|----|----|----|------|----|----|---|
|     |    |    |    |      |    |    |   |

## **SYMBOL**







## LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL  | PARAMETER   | CONDITIONS  |               | MA                              | ۱X.                | UNIT                  |
|---|---|---|---------------|---------------------------------|--------------------|-----------------------|
| $V_{DRM}$   | Repetitive peak off-state voltages  |   | -             | <b>-600</b><br>600 <sup>1</sup> | <b>-800</b><br>800 | V                     |
| I <sub>T(RMS)</sub><br>I <sub>TSM</sub>               | RMS on-state current<br>Non-repetitive peak<br>on-state current                     | full sine wave; $T_{hs} \le 38 ^{\circ}\text{C}$ full sine wave; $T_j = 25 ^{\circ}\text{C}$ prior to surge | -             |                                 | 6                  | Α .                   |
|   |   | t = 20 ms<br>t = 16.7 ms  | -             |                                 | 10<br>50           | A<br>A                |
| l²t<br>dl <sub>⊤</sub> /dt                            | I <sup>2</sup> t for fusing<br>Repetitive rate of rise of<br>on-state current after | t = 10  ms<br>$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$<br>$dI_G/dt = 0.2 \text{ A}/\mu\text{s}$        | -             | 9                               |                    | A<br>A <sup>2</sup> s |
|   | triggering  | T2+ G+<br>T2+ G-<br>T2- G-  | -<br>-<br>-   | 5<br>5                          | 0<br>0<br>0        | A/μs<br>A/μs<br>A/μs  |
| I <sub>GM</sub><br>V <sub>GM</sub><br>P <sub>GM</sub> | Peak gate current Peak gate voltage Peak gate power                                 | T2- G+  | -<br>-<br>-   | 2                               | 0<br>2<br>5        | A/μs<br>A<br>V<br>W   |
| P <sub>G(AV)</sub><br>T <sub>stg</sub>                | Average gate power Storage temperature Operating junction temperature               | over any 20 ms period   | -<br>-40<br>- |                                 | .5<br>50<br>25     | O,O,A                 |

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<sup>1</sup> Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15  $A/\mu s$ .

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# **ISOLATION LIMITING VALUE & CHARACTERISTIC**

 $T_{hs}$  = 25 °C unless otherwise specified

| SYMBOL            | PARAMETER  | CONDITIONS  | MIN. | TYP. | MAX. | UNIT |
|-------------------|--|---|------|------|------|------|
| V <sub>isol</sub> | R.M.S. isolation voltage from all three terminals to external heatsink | f = 50-60 Hz; sinusoidal<br>waveform;<br>R.H. ≤ 65%; clean and dustfree | -    | -    | 2500 | V    |
| C <sub>isol</sub> | Capacitance from T2 to external heatsink                               | f = 1 MHz   | -    | 10   | -    | pF   |

# THERMAL RESISTANCES

| SYMBOL               | PARAMETER                               | CONDITIONS  | MIN. | TYP. | MAX.       | UNIT       |
|----------------------|---|---|------|------|------------|------------|
| R <sub>th j-hs</sub> | Thermal resistance junction to heatsink | full or half cycle with heatsink compound without heatsink compound |      | -    | 4.0<br>5.5 | K/W<br>K/W |
| R <sub>th j-a</sub>  | Thermal resistance junction to ambient  | in free air   | -    | 55   | 1          | K/W        |

## STATIC CHARACTERISTICS

T<sub>i</sub> = 25 °C unless otherwise stated

| SYMBOL          | PARAMETER                                | CONDITIONS   | MIN.           | TYP.              | MAX.           |                 |                | UNIT           |
|-----------------|--|--|----------------|-------------------|----------------|-----------------|----------------|----------------|
| I <sub>GT</sub> | Gate trigger current                     | <b>BT139X-</b> $V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$   |                |                   |                | F               | G              |                |
| Gi              | 33                                       | T2+ G+<br>T2+ G-   | -              | 5<br>8            | 35<br>35       | 25<br>25        | 50<br>50       | mA<br>mA       |
|                 |  | T2- G-<br>T2- G+   | -<br>-         | 10<br>22          | 35<br>70       | 25<br>70        | 50<br>100      | mA<br>mA       |
| I <sub>L</sub>  | Latching current                         | V <sub>D</sub> = 12 V; I <sub>GT</sub> = 0.1 A<br>T2+ G+<br>T2+ G-<br>T2- G-                                     | -<br>-<br>-    | 7<br>20<br>8      | 40<br>60<br>40 | 40<br>60<br>40  | 60<br>90<br>60 | mA<br>mA<br>mA |
| I <sub>H</sub>  | Holding current                          | $V_D = 12 \text{ V}; I_{GT} = 0.1 \text{ A}$   | -              | 10<br>6           | 60<br>45       | 60<br>45        | 90<br>60       | mA<br>mA       |
| $V_{\text{T}}$  | On-state voltage<br>Gate trigger voltage | $I_T = 20 \text{ A}$<br>$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}$<br>$V_D = 400 \text{ V}; I_T = 0.1 \text{ A};$ | -<br>-<br>0.25 | 1.2<br>0.7<br>0.4 |                | 1.6<br>1.5<br>- |                | ><br>><br>>    |
| I <sub>D</sub>  | Off-state leakage current                | $ \begin{aligned} &  T_j = 125 \text{ °C} \\ &  V_D =  V_{DRM(max)}; \\ &  T_j = 125 \text{ °C} \end{aligned} $  | -              | 0.1               |                | 0.5             |                | mA             |

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# **DYNAMIC CHARACTERISTICS**

 $T_j = 25$  °C unless otherwise stated

| SYMBOL                | PARAMETER                                      | CONDITIONS   |     | MIN.           |                 | TYP. | MAX. | UNIT |
|-----------------------|--|--|-----|----------------|-----------------|------|------|------|
| dV <sub>D</sub> /dt   | Critical rate of rise of off-state voltage     | <b>BT139X-</b> $V_{DM} = 67\% V_{DRM(max)};$ $T_i = 125 ^{\circ}C;$ exponential  | 100 | <b>F</b><br>50 | <b>G</b><br>200 | 250  | -    | V/μs |
| dV <sub>com</sub> /dt | Critical rate of change of commutating voltage | waveform; gate open circuit $V_{DM} = 400 \text{ V}; T_j = 95 ^{\circ}\text{C};$ $I_{T(RMS)} = 16 \text{ A};$ $dI_{com}/dt = 7.2 \text{ A/ms};$ gate     | -   | -              | 10              | 20   | -    | V/μs |
| t <sub>gt</sub>       | Gate controlled turn-on time                   | $ \begin{array}{l} \text{open circuit} \\ I_{TM} = 20 \text{ A; } V_D = V_{DRM(max)}; \\ I_G = 0.1 \text{ A; } dI_G/dt = 5 \text{ A}/\mu s \end{array} $ | -   | -              | -               | 2    | 1    | μs   |

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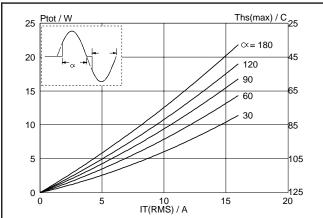


Fig.1. Maximum on-state dissipation,  $P_{tot}$ , versus rms on-state current,  $I_{T(RMS)}$ , where  $\alpha =$  conduction angle.

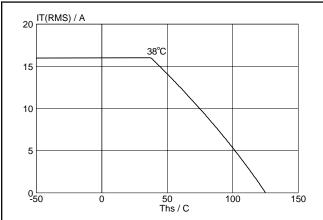


Fig.4. Maximum permissible rms current  $I_{T(RMS)}$ , versus heatsink temperature  $T_{hs}$ .

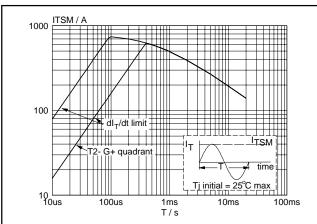


Fig.2. Maximum permissible non-repetitive peak on-state current  $I_{TSM}$ , versus pulse width  $t_p$ , for sinusoidal currents,  $t_p \le 20$ ms.

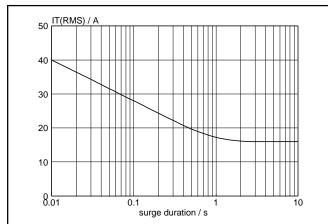


Fig.5. Maximum permissible repetitive rms on-state current  $I_{T(RMS)}$ , versus surge duration, for sinusoidal currents, f = 50 Hz;  $T_{hs} \le 38$  °C.

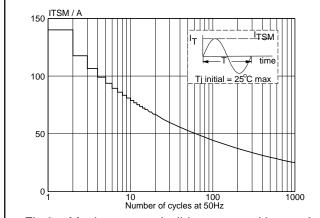
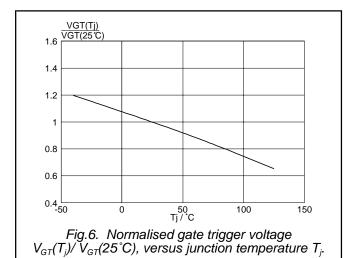
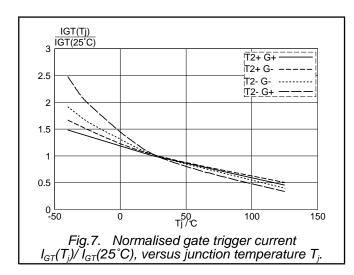


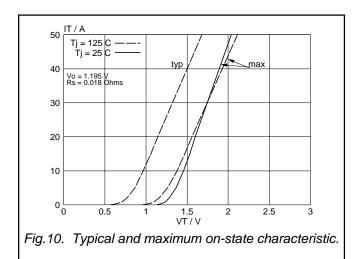
Fig.3. Maximum permissible non-repetitive peak on-state current  $I_{TSM}$ , versus number of cycles, for sinusoidal currents, f = 50 Hz.

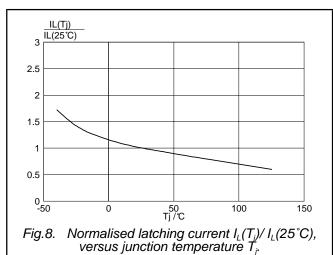


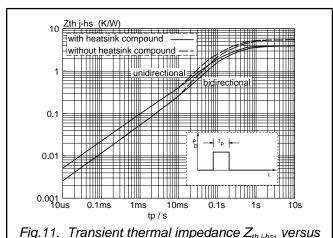
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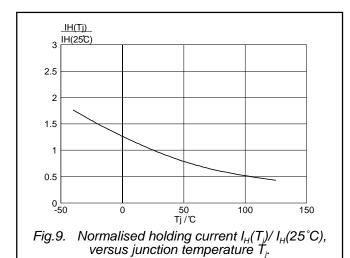
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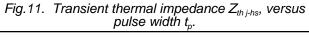












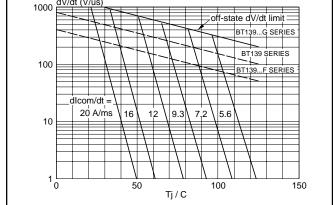
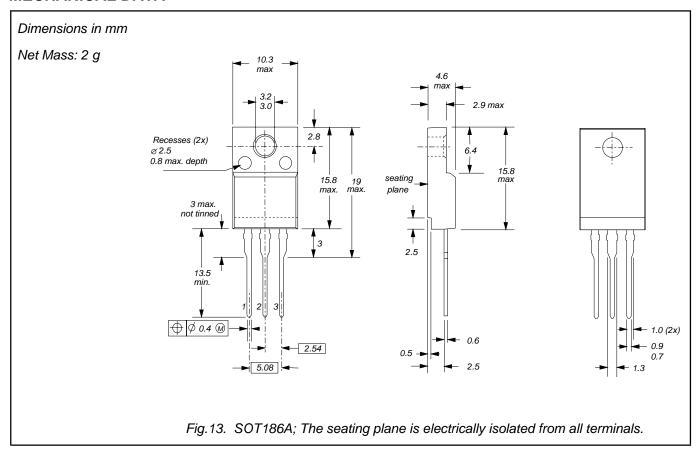


Fig. 12. Typical commutation dV/dt versus junction temperature, parameter commutation dl<sub>7</sub>/dt. The triac should commutate when the dV/dt is below the value on the appropriate curve for pre-commutation dl<sub>7</sub>/dt.

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## **MECHANICAL DATA**



- Notes
  1. Refer to mounting instructions for F-pack envelopes.
  2. Epoxy meets UL94 V0 at 1/8".

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## **DEFINITIONS**

| DATA SHEET STATUS              |   |  |  |  |  |  |
|--------------------------------|---|--|--|--|--|--|
| PRODUCT<br>STATUS <sup>3</sup> | DEFINITIONS   |  |  |  |  |  |
| Development                    | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice  |  |  |  |  |  |
| Qualification                  | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product                                     |  |  |  |  |  |
| Production                     | This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A |  |  |  |  |  |
|                                | PRODUCT<br>STATUS <sup>3</sup> Development  Qualification   |  |  |  |  |  |

#### Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

## **Application information**

Where application information is given, it is advisory and does not form part of the specification.

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